THERMAL INTERFACE APPARATUS, SYSTEMS, AND METHODS

Abstract of the Disclosure

An apparatus and system, as well as fabrication methods therefor, may include a unitary, substantially uniformly distributed transfer material coupled to a carrier material.

"Express Mail" mailing label number: <u>EV 332571722 US</u> Date of Deposit: <u>June 24, 2003</u>

This paper or fee is being deposited on the date indicated above with the United States Postal Service pursuant to 37 CFR 1.10, and is addressed to the Commissioner for Patents, Mail Stop Patent Application, P.O. Box 1450, Alexandria, VA 22313-1450.